

TDA7389

4 x 45W quad bridge car radio amplifier

Features

- High output power:
 - 4 x 45W/4Ω max.
 - 4 x 28W/4Ω @ 14.4V, 1KHz, 10%
- Low distortion
- Low output noise
- Stand-by function
- Mute function
- Automute at min. supply voltage detection
- Low external component count:
 - Internally fixed gain (26dB)
 - No external compensation
 - WWW.DZSG.CO No bootstrap capacitors
- Clipping detector
- Diagnostic facility for:
 - Out to GND short
 - Out to V_S short
 - Thermal shutdown

Protections:

- Output short circuit to GND, to V_S, across the
- Very inductive loads
- Overrating chip temperature with soft thermal



- Load dump voltage
- Fortuitous open GND
- Reversed battery
- **ESD**

Description

The TDA7389 is a new technology class AB Audio Power Amplifier in Flexiwatt 25 package designed for high end car radio applications.

Thanks to the fully complementary PNP/NPN output configuration the TDA7389 allows a rail to rail output voltage swing with no need of bootstrap capacitors.

Table 1. **Device summary**

Order code	Package	Packing Packing
TDA7389	Flexiwatt 25	Tube

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Pins connection and block diagrams 1

Figure 1. **Block diagram**

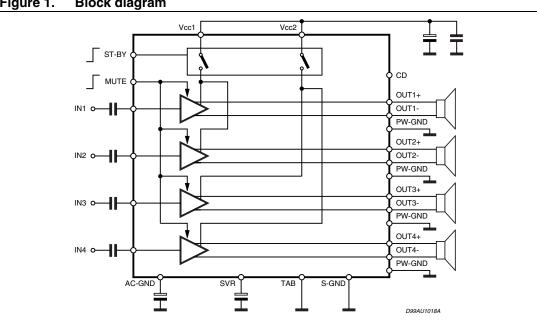
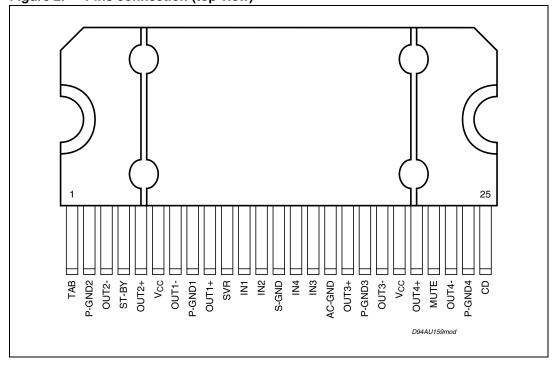


Figure 2. Pins connection (top view)



2 Electrical specifications

2.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _S	Operating supply voltage	18	V
V _{S (DC)}	DC supply voltage	28	V
V _{S (pk)}	Peak supply voltage (t = 50ms)	50	V
I _O	Output peak current: Repetitive (duty cycle 10% at f = 10Hz) Non repetitive (t = 100µs)	4.5 5.5	А
P _{tot}	Power dissipation, (T _{case} = 70°C)	80	W
Tj	Junction temperature	150	°C
T _{stg}	Storage temperature	– 55 to 150	°C

2.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{th j-amb}	Thermal resistance junction to ambient max.	1	°C/W

2.3 Electrical characteristics

 Table 4.
 Electrical characteristics

(V_S = 14.4V; f = 1KHz; R_g = 600 Ω ; R_L = 4 Ω ; T_{amb} = 25°C; Refer to the test and application diagram (*Figure 14*), unless otherwise specified.)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
I _{q1}	Quiescent current	$R_L = \infty$		150	350	mA
V _{OS}	Output offset voltage	Play Mode			±80	mV
dV	During mute on/off output offset voltagef	ITU R-ARM weighted	-10		10	- mV
dV _{OS}	During st-by on/off output offset voltage		-50		50	
G _v	Voltage gain		25	26	27	dB
ΔG _v	Channel gain unbalance				±1	dB
Po	Output power	THD = 10%; V _S = 14.4V	26	28		W
P _{o max}	Max.output power ⁽¹⁾	V _S = 14.4V	41	45		W

Table 4. Electrical characteristics (continued)

 $(V_S = 14.4V; f = 1KHz; R_g = 600\Omega; R_L = 4\Omega; T_{amb} = 25^{\circ}C; Refer to the test and application diagram ($ *Figure 14*), unless otherwise specified.)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
THD	Distortion	$P_0 = 4W$		0.04	0.10	%
	Outside size	"A" Weighted		50	70	μV
e _{No}	Output noise	Bw = 20Hz to 20KHz		70	100	μV
SVR	Supply voltage rejection	$f = 100Hz; V_r = 1V_{rms}$	50	75		dB
f _{ch}	High cut-off frequency	$P_0 = 0.5W$	100	200		KHz
R _i	Input Impedance		70	100	150	ΚΩ
	Cross talk	f = 1KHz; Po = 4W	60	75		dB
C _T	Cioss taik	f = 10KHz; Po = 4W		60		dB
1	Ct Dy gurrant consumption	$V_{St-By} = 1.2V$			50	- μΑ
I _{SB}	St-By current consumption	V _{St-By} = 0V			25	
I _{pin4}	St-By pin current	V _{St-By} = 1.2 to 2.6V			±1	μА
V _{SB out}	St-By OUT threshold voltage	(Amp: ON)	2.6			٧
V _{SB IN}	St-By IN threshold voltage	(Amp: OFF)			1.2	٧
A _M	Mute attenuation	P _{Oref} = 4W	80	90		dB
V _{M out}	Mute OUT threshold voltage	(Amp: Play)	2.6			٧
V _{M in}	Mute IN threshold voltage	(Amp: Mute)			1.2	٧
V _{AM in}	V _S automute threshold	(Amp: Mute); Att \geq 80dB; P _{Oref} = 4Ω (Amp: Play); Att < 0.1dB;			6.5	V
		$P_{O} = 0.5W$		7.6	8.5	
I _{pin22}	Muting pin current	V _{MUTE} = 1.2V (Source current)	5	11	20	μА
		V _{MUTE} = 2.6V	-5	-	-20	
Clipping de	etector					
CD _{LK}	Clip det high leakage current	CD Off			1	μА
CD _{SAT}	Clip det sat voltage	DC On; I _{CD} = 1mA		0.2	0.4	٧
CD _{THD}	Clip det THD level	Pout > 16W			2	%

^{1.} Saturated square wave output.

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2.4 Electrical characteristic curves

Figure 3. Quiescent current vs. supply voltage

Figure 4. Quiescent output voltage vs. supply voltage

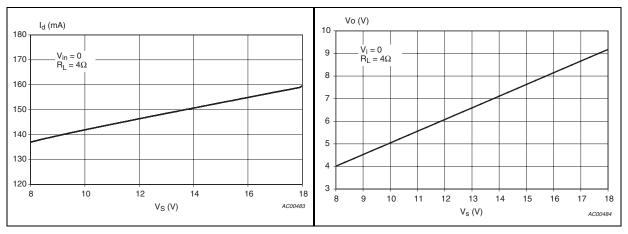


Figure 5. Output power vs. supply voltage

Figure 6. Maximum output power vs. supply voltage

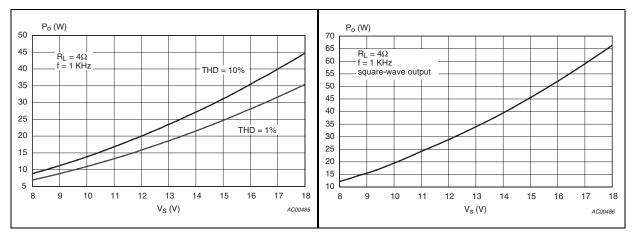


Figure 7. Distortion vs. output power

Figure 8. Distortion vs. frequency

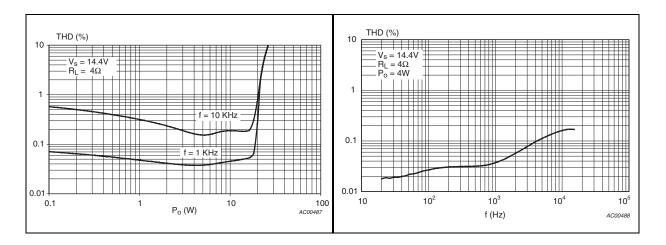


Figure 9. Supply voltage rejection vs. frequency

Figure 10. Crosstalk vs. frequency

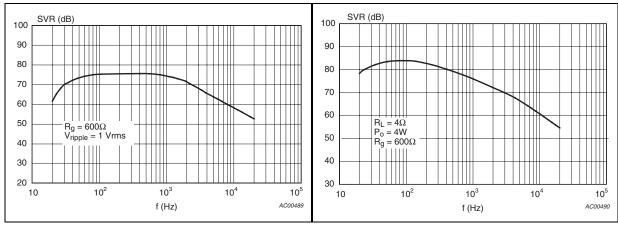


Figure 11. Output noise vs. source resistance Figure 12. Power dissipation & efficiency vs. output power

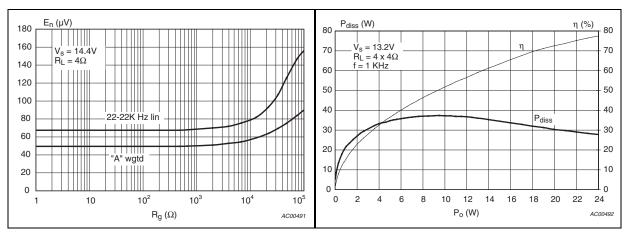
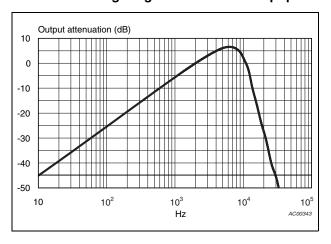
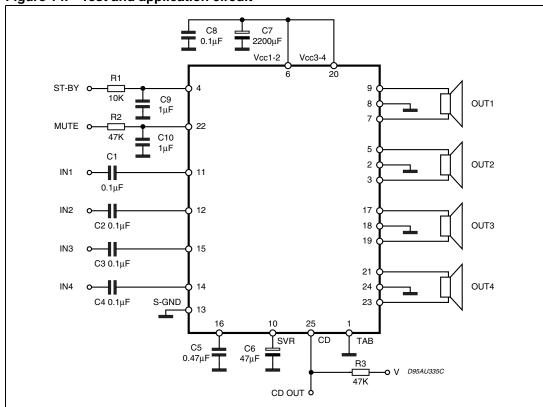


Figure 13. ITU R-ARM frequency response, weighting filter for transient pop



2.5 Test and application circuit

Figure 14. Test and application circuit



TDA7389 Application hints

3 Application hints

Ref. to the circuit of Figure 14.

3.1 SVR

Besides its contribution to the ripple rejection, the SVR capacitor governs the turn ON/OFF time sequence and, consequently, plays an essential role in the pop optimization during ON/OFF transients.

To conveniently serve both needs, **ITS MINIMUM RECOMMENDED VALUE IS 22\mu F**, $47\mu F$ can be used to optimize pop performances.

3.2 Input stage

The TDA7389's inputs are ground-compatible and can stand very high input signals (± 8Vpk) without any performances degradation.

If the standard value for the input capacitors (0.1 μ F) is adopted, the low frequency cut-off will amount to 16 Hz.

The input capacitors should be 1/4 of the capacitor connected to AC-GND pin for optimum pop performances.

3.3 Stand-by and Muting

Stand-by and Muting facilities are both 3.3V CMOS-COMPATIBLE. If unused, a straight connection to V_s of their respective pins would be admissible.

Conventional/low-power transistors can be employed to drive muting and stand-by pins in absence of true CMOS ports or microprocessors. R-C cells have always to be used in order to smooth down the transitions for preventing any audible transient noises.

Since a DC current of about 10 μ A normally flows out of pin 23, the maximum allowable muting-series resistance (R₂) is 70K Ω , which is sufficiently high to permit a muting capacitor reasonably small (about 1 μ F).

If R_2 is higher than recommended, the involved risk will be that the voltage at pin 23 may rise to above the 1.2V threshold voltage and the device will consequently fail to turn OFF when the mute line is brought down.

About the stand-by, the time constant to be assigned in order to obtain a virtually pop-free transition has to be slower than 2.5V/ms.

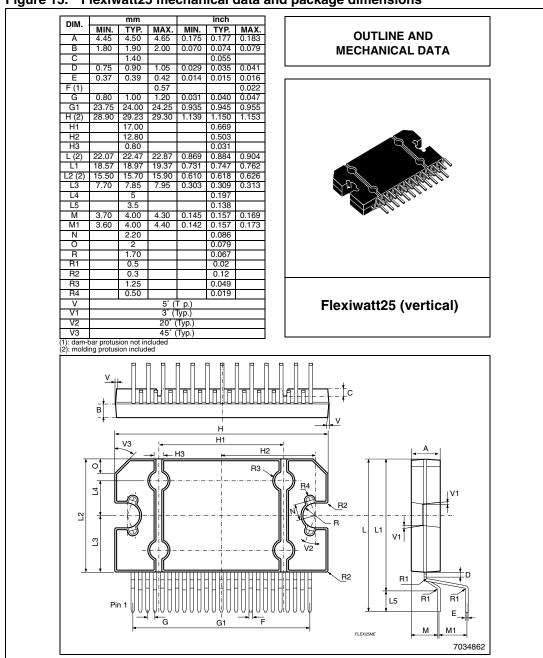
Package information TDA7389

4 Package information

In order to meet environmental requirements, ST offers this device in ECOPACK[®] packages. This package has a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 15. Flexiwatt25 mechanical data and package dimensions



TDA7389 Revision history

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
9-Nov-2007	1	Initial release.

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